P278, Metallized Impregnated Paper, Class X1, 480 VAC



Overview

Multilayer metallized paper encapsulated and impregnated in self-extinguishing material that meets the requirements of UL 94 V=0.

Applications

Typical applications include worldwide use as an electromagnetic interference suppressor in all X1 and across-the-line applications.

Benefits

· Approvals: ENEC, UL, cUL

Rated voltage: 480 VAC 50/60 Hz
Capacitance range: 0.001 – 0.15 μF
Lead Spacing: 10.2 – 25.4 mm

• Capacitance tolerance: ±20%

Climatic category: 40/110/56, IEC 60068-1

• Tape & Reel in accordance with IEC 60286-2

· RoHS compliance and lead-free terminations

Operating temperature range of -40°C to +110°C

100% screening factory test at 2,700 VDC

 Highest possible safety regarding active and passive flammability

• Excellent self-healing properties that ensure long life, even when subjected to frequent over-voltages

· Good resistance to ionization due to impregnated paper dielectric

 Impregnated paper that ensures excellent stability and reliability properties, particularly in applications that operate continuously



Part Number System

P	278	Н	E	102	M	480	A
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	X1, Metallized Paper	H = 10.2 Q = 15.2 C = 20.3 S = 22.5 E = 25.4	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	480 = 480	See Ordering Options Table

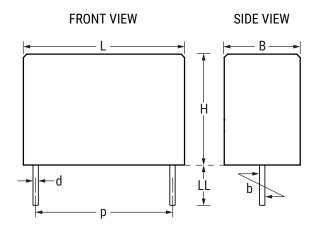


Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Part Number (Insert at 14th character)
	Standard Lead and Packaging Options		
	Bulk - Short Leads	6 +0/-1	С
	Bulk – Maximum Length Leads	30 +5/-0	A
10.2	Tape & Reel (Standard Reel)	$H_0 = 18.5 \pm 0.5$	L
	Other Lead and Packaging Options		
	Ammo Pack formed to	$H_0 = 18.5 \pm 0.5$	XLAF1
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	Р
	Chandend Lood and Destroiting On the		
	Standard Lead and Packaging Options	6.0/1	0
	Bulk - Short Leads	6 +0/-1	C
15.2	Bulk – Maximum Length Leads	30 +5/-0	A
	Tape & Reel (Standard Reel)	H ₀ = 18.5 ±0.5	L
	Other Lead and Packaging Options	11 10 5 10 5	D.
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	Р
	Standard Lead and Packaging Options		
	Tray – Short Leads	6 +0/-1	С
00.0	Bulk – Maximum Length Leads	30 +5/-0	Α
20.3	Tape & Reel (Standard Reel)	H ₀ = 18.5 ±0.5	L
	Other Lead and Packaging Options	·	
	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	Р
	Chandend Lood and Device in C. C.		
	Standard Lead and Packaging Options	6 10/ 1	0
	Tray - Short Leads	6 +0/-1	C
22.5	Bulk - Maximum Length Leads	30 +5/-0	A
	Tape & Reel (Standard Reel)	H ₀ = 18.5 ±0.5	L
	Other Lead and Packaging Options	U = 10 E ±0 E	D
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	Р
	Standard Lead and Packaging Options		
25.4	Tray – Short Leads	6 +0/-1	С
	Bulk – Maximum Length Leads	30 +5/-0	A



Dimensions - Millimeters



Size		p		В		Н	L		L		d		b						
Code	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Tolerance								
HE	10.2	±0.4	3.9	Maximum	7.5	Maximum	13.5	Maximum	0.6	±0.05	±0.4								
НН	10.2	±0.4	4.1	Maximum	8.2	Maximum	13.5	Maximum	0.6	±0.05	±0.4								
HL	10.2	±0.4	5.1	Maximum	10.5	Maximum	13.5	Maximum	0.6	±0.05	±0.4								
QE	15.2	±0.4	5.2	Maximum	10.5	Maximum	18.5	Maximum	0.8	±0.05	±0.4								
QJ	15.2	±0.4	5.5	Maximum	11.1	Maximum	18.5	Maximum	0.8	±0.05	±0.4								
QS	15.2	±0.4	8.5	Maximum	14.3	Maximum	18.5	Maximum	0.8	±0.05	±0.4								
CE	20.3	±0.4	7.6	Maximum	14.0	Maximum	24.0	Maximum	0.8	±0.05	±0.4								
CJ	20.3	±0.4	9.0	Maximum	15.0	Maximum	24.0	Maximum	0.8	±0.05	±0.4								
CP	20.3	±0.4	11.3	Maximum	16.5	Maximum	24.0	Maximum	0.8	±0.05	±0.4								
SJ	22.5	±0.4	8.0	Maximum	17.0	Maximum	27.0	Maximum	0.8	±0.05	±0.4								
SP	22.5	±0.4	10.0	Maximum	19.0	Maximum	27.0	Maximum	0.8	±0.05	±0.4								
SU	22.5	±0.4	12.0	Maximum	22.0	Maximum	27.0	Maximum	0.8	±0.05	±0.4								
EJ	25.4	±0.4	12.1	Maximum	19.0	Maximum	30.5	Maximum	1.0	±0.05	±0.4								
EL	25.4	±0.4	15.3	Maximum	22.0	Maximum	30.5	Maximum	1.0	±0.05	±0.4								
			Not	e: See Orderin	g Options Ta	ble for lead ler	ngth (LL) opti	ons.	Note: See Ordering Options Table for lead length (LL) options.										



Performance Characteristics

Rated Voltage	480 VAC 50/60Hz				
Capacitance Range	0.001 - 0.15 μF				
Capacitance Tolerance	±20%				
Temperature Range	-40°C to +110°C				
Climatic Category	40/110/56/B				
Approvals	ENEC, UL, cUL				
	Maximum Values at +23°C				
Dissipation Factor	1 kHz 1.3%				
Test Voltage Between Terminals	The 100% screening factory test in 2,700 VDC. The voltage level is se requirements in applicable equipmelectrical characteristics are checked. This test may not be repeated due KEMET is not liable for any failure test again.	elected to meet the nent standards. All cked after the test. to potential capacitor damage.			
Insulation Resistance	Minimum Value Bo	etween Terminals:			
modiation resistance	≥ 12,000 MΩ				
In DC Applications	Recommended voltage ≤ 1,000 VDC				
Resonance Frequency	Tabulated self-resonance freque refer to 5 mm lead length	ncies (f ₀)			

Environmental Test Data

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	$1.25~\text{x}~\text{V}_{_{R}}~\text{VAC}~50~\text{Hz}$, once every hour increase to 1,000 VAC for 0.1 seconds, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 500 Hz at 0.75 mm or 98m/seconds ²
Bump	IEC 60068-2-29 Test Eb	4,000 bumps at 390 m/seconds ²
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V _R + 20 surge pulses at 4.0 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle-flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days



Approvals

Certification Body	Mark	Specification	File Number	
Intertek Semko AB		EN/IEC 60384-14	SE/0140-35A	
UL	c Al us	UL 60384-14 CAN/CSA-E60384-14-09	E73869	

Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.



Table 1 - Ratings & Part Number Reference

Capacitance	Maximu	m Dimensior	ns in mm	Lead Spacing f _o		dV/dt	KEMET
Value (µF)	В	Н	L	(p)	(MHz)	(V/µs)	Part Number
0.001	3.9	7.5	13.5	10.2	53	2,000	P278HE102M480(1)
0.0015	3.9	7.5	13.5	10.2	44	2,000	P278HE152M480(1)
0.0022	3.9	7.5	13.5	10.2	37	2,000	P278HE222M480(1)
0.0033	4.1	8.2	13.5	10.2	30	2,000	P278HH332M480(1)
0.0047	5.1	10.5	13.5	10.2	24	2,000	P278HL472M480(1)
0.0068	5.2	10.5	18.5	15.2	18.5	1,400	P278QE682M480(1)
0.010	5.2	10.5	18.5	15.2	15.5	1,400	P278QE103M480(1)
0.015	5.5	11.1	18.5	15.2	13	1,400	P278QJ153M480(1)
0.022	8.5	14.3	18.5	15.2	9.6	1,400	P278QS223M480(1)
0.033	7.6	14.0	24.0	20.3	9.6	1,000	P278CE333M480(1)
0.047	9.0	15.0	24.0	20.3	7.5	1,000	P278CJ473M480(1)
0.068	11.3	16.5	24.0	20.3	6.2	1,000	P278CP683M480(1)
0.033	8.0	17.0	27.0	22.5	7.2	1,000	P278SJ333M480(1)
0.047	8.0	17.0	27.0	22.5	6	1,000	P278SJ473M480(1)
0.068	10.0	19.0	27.0	22.5	4.8	1,000	P278SP683M480(1)
0.1	12.0	22.0	27.0	22.5	3.6	600	P278SU104M480(1)
0.1	12.1	19.0	30.5	25.4	3.9	600	P278EJ104M480(1)
0.15	15.3	22.0	30.5	25.4	3.2	600	P278EL154M480(1)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f° (MHz)	dV/dt (V/µs)	KEMET Part Number

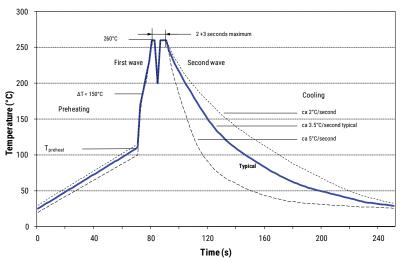
⁽¹⁾ Insert ordering code for lead type and packaging. See Ordering Options Table for available options.



Soldering Process

The implementation of the RoHS Directive has required the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from 183 °C for SnPb eutectic alloys to 217 - 221 °C for the new alloys. As a result, the heat stress to components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170 °C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (lead spacings 5 - 10 mm). Great care must be taken during soldering. The solder profiles from KEMET are highly recommended. You may also refer to the wave soldering curve from IEC Publication 61760-1 Edition 2. Consult KEMET with any questions.

Figure 1
Wave Soldering Recommendations





Soldering Process cont'd

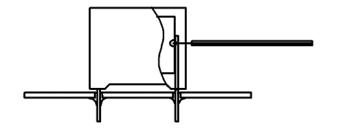
Wave Soldering Recommendations cont'd

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric film	Maximun	n Preheat Ten	perature	Maximum Peak Soldering Temperature		
material	Capacitor Pitch ≤ 10 mm			Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	130°C	270°C	270°C	
Polypropylene	100°C	110°C	130°C	260°C	270°C	
Paper	130°C 130°C		140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor: set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

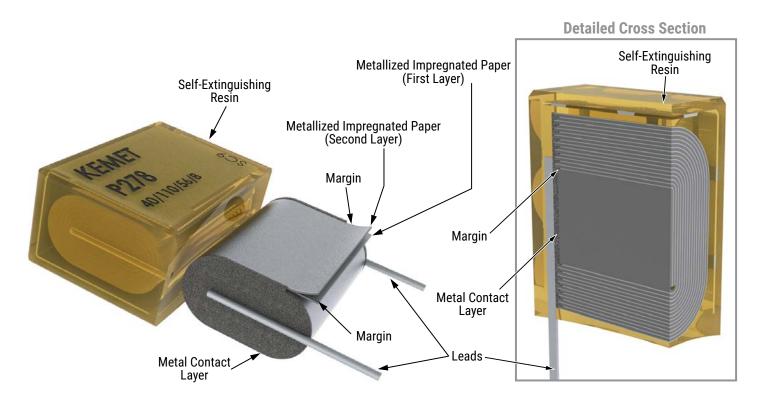
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath, as in normal-flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and then pressed against the lower surface of the board to solder the components.

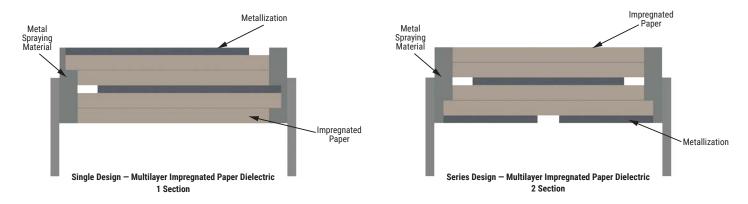
The temperature profile for selective soldering is similar to the temperature profile for double-wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double-wave flow soldering, and great care must be taken so that the parts do not overheat.



Construction

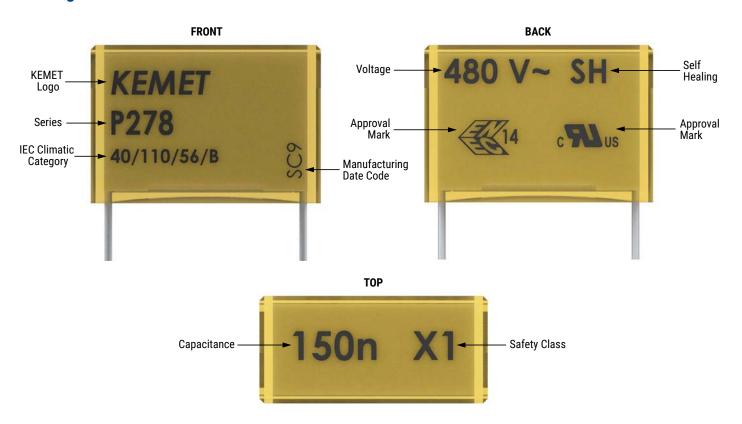


Winding Scheme





Marking



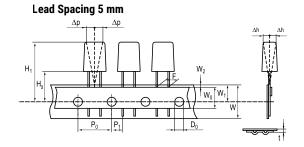


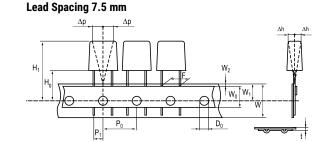
Packaging Quantities

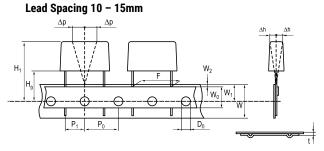
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 360 mm	Large Reel 500 mm	Ammo Formed		
	3.9	7.5	13.5	2,000	1,000	700	1,400	800		
10.2	4.1	8.2	13.5	2,000	1,000	600		780		
	5.1	10.5	13.5	1,600	800	600	1,200	630		
	5.5	12.5	18.0	1,000	500	600				
	6.5	12.5	18.0	600	400	400				
	7.5	14.5	18.0	600	400	400				
	8.5	16.0	18.0	400	250	400				
15.2	5.2	10.5	18.5	1000	500	600				
10.2	5.5	11.1	18.5	1,000	500	500				
	6.0	12.5	18.5	600	400	400				
	7.3	13.0	18.5	600	400	400	800			
	7.8	13.5	18.5	600	400	400				
	8.5	14.3	18.5	500	300	350				
	7.6	110	24.2	1.500	050	050	500			
	7.6	14.0	24.0	1,500	250	250	500			
20.3	8.4	14.0	24.0	1,200	200	250	500			
20.0	9.0	15.0	24.0	1,500	200	250				
	11.3	16.5	24.0	1,000	150	180	400			
	8.0	17.0	27.0	1,200	200					
22.5	10.0	19.0	27.0	1,000	150	200				
22.3	12.0	22.0	27.0	800	100	180	350			
	12.0	22.0	27.0	000	100	100	330			
	10.6	16.1	30.5	1,000	150					
05.4	10.5	17.3	30.5	1,000	100					
25.4	12.1	19.0	30.5	800	100					
	15.3	22.0	30.5	600	75					

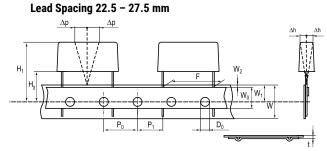


Lead Taping & Packaging (IEC 60286-2)

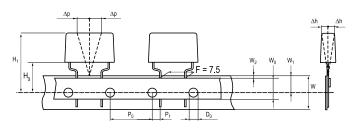








Formed Leads from 10 and 15 mm to 7.5 mm



Taping Specification

Dimensions in mm											
Lead Spacing	+6/-0.1	F	5	7.5	Formed 7.5	10	15	22.5	27.5	F	
Carrier Tape Width	±0.5	W	18	18	18	18	18	18	18	18 +1/-0.5	
Hold-down Tape Width	Minimum	W _o	5	5	5	5	5	5	5		
Position of Sprocket Hole	±0.5	W ₁	9	9	9	9	9	9	9	9 +0.75/-0.5	
Distance Between Tapes	Maximum	W ₂	3	3	3	3	3	3	3	3	
Sprocket Hole Diameter	±0.2	D ₀	4	4	4	4	4	4	4	4	
Feed Hole Lead Spacing	±0.3	P ₀ (1)	12.7	12.7	12.7 (4)	12.7	12.7	12.7	12.7	12.7	
Distance Lead - Feed Hole	±0.7	P ₁	3.85	3.75	3.75	7.7	5.2	5.3	5.3	P1	
Deviation Tape - Plane	Maximum	Δр	1.3	1.3	1.3	1.3	1.3	1.3	1.3	1.3	
Lateral Deviation	Maximum	Δh	2	2	2	2	2	2	2	2	
Total Thickness	±0.2	t	0.7	0.7	0.7	0.7	0.7	0.9 maximum	0.9 maximum	0.9 maximum	
Sprocket Hole/Cap Body	Nominal	H ₀ (2)	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.5±0.5	18.0 +2/-0	
Sprocket Hole/ Top of Cap Body	Maximum	H ₁ (3)	32	31	43	43	43	58	58	58 maximum	

⁽¹⁾ Maximum cumulative feed hole error, 1 mm per 20 parts

^{(2) 16.5} mm available on request

⁽³⁾ Depending on case size

^{(4) 15} mm available on request



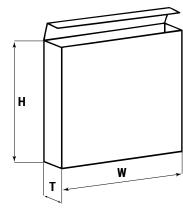
Lead Taping & Packaging (IEC 60286-2) cont'd

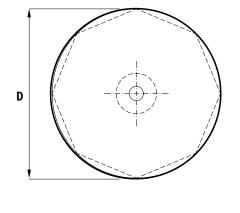
Ammo Specifications

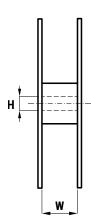
Carios	Dir	Dimensions (mm)					
Series	Н	W	Т				
P278	330	330	50				

Reel Specifications

Series	Dimensions (mm)		
	D	Н	W
P278	360 500	30	46 (Max)







Manufacturing Date Code (IEC-60062)

Y = Year, Z = Month				
Year	Code	Month	Code	
2000	M	January	1	
2001	N	February	2	
2002	Р	March	3	
2003	R	April	4	
2004	S	May	5	
2005	Т	June	6	
2006	U	July	7	
2007	V	August	8	
2008	W	September	9	
2009	X	October	0	
2010	Α	November	N	
2011	В	December	D	
2012	С			
2013	D			
2014	E			
2015	F			
2016	Н			
2017	J			
2018	K			
2019	L			
2020	M			



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